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Deformable Bioelectronics Based on Functional Micro/nanomaterials, Volume II

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Message from the Guest Editor

Deformable hipelectronics hased functional on micro/nanomaterials, the topic of this Special Issue, have attracted huge attention owing to their tremendous potential in wearable and implantable applications. Specifically, high-performance functional micro/nanomaterials are able to allow the deformable electronics to be more feasible in next-generation healthcare and medicine due to their exceptional biocompatibility, flexibility, and even bioresorbability while maintaining high electrical performances. Therefore, the multifunctional deformable electronics integrated with such superior micro/nanomaterials have been expected to be comparable to conventional material-driven devices in the near future.













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Editor-in-Chief

Message from the Editor-in-Chief

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